# Product Qualification Report

# **AIMZA75R040M2H**

CoolSiC™

## Description

This product qualification report describes the characteristics of the product with respect to quality and reliability.

The qualification sample selection was done on production lots which were manufactured and tested on standard production processes and meet the defined requirements.

The qualification test results of those products as outlined in this document are based on **AEC Q101** for target applications and may reference existing qualification results of similar products. Such referencing is justified by the structural similarity of the products.

## Qualification Assessment

Fully qualified according to **AEC Q101** and assessed as PASS

For further information about comparable products, please contact the nearest Infineon Technologies office (www.infineon.com).

## AIMZA75R040M2H qualified 2025

## PG-TO247-4
## MSL: n.a

**Electrical Stress Test Results:**

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|---|---|---|---|---|---|---|
| Parametric Verification | PV | -55°C, +25°C, +175°C | | 3 x 30 | 0 / 90 | PASS |
| High Temperature Reverse Bias JESD22 A108 | HTRB* | Ta = 175°C $V_{DS}$ = 100% $V_{DS\ max}$ | 1000 h | 3 x 77 | 0 / 231 | PASS |
| High Temperature Gate stress JESD22-A108 | HTGS* | Ta = 175°C $V_{GS}$ = +25V, -20V | 1000 h | 3 x 77 | 0 / 231 | PASS |
| High Humidity High Temp. Reverse Bias JESD22 A101 | H3TRB* | Ta = 85°C RH = 85% $V_{DS}$ = 80% $V_{DS\ max}$ | 1000 h | 3 x 77 | 0 / 231 | PASS |
| Intermitted Operational Life Test MIL-STD 750 / Meth.1037 | IOL* | Delta T =100K | 15000 cyc | 3 x 77 | 0 / 231 | PASS |
| ESD (HBM) JESD22-A114 | HBM | Class 1C ( 1000 V to < 2000 V ) | | | | PASS |
| ESD (CDM) JESD22-C101 | CDM | Class C3 ( > 1000 V ) | | | | PASS |

**Environmental Stress Test Results:**

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|---|---|---|---|---|---|---|
| Pre-conditioning J-STD020 / JESD22 A113 | PC | MSL and 3 x reflow at 260°C | 0 h | n.a | n.a | n.a |
| Temperature Cycling JESD22 A104 | TC* | -55°C, +150°C | 1000 cyc | 3 x 77 | 0 / 231 | PASS |
| Unbiased Highly Accelerated StressTest JESD22 A118 | UHAST* | Ta = 130°C RH = 85% | 96h | 3 x 77 | 0 / 231 | PASS |

**Mechanical Stress Test Results:**

| Test Description | Abbr. | Condition | Duration | Lots | Fail/Qty | Result |
|---|---|---|---|---|---|---|
| Destructive Physical Analysis | DPA | samples from AC, UHAST & TC | | 3 | 0 / 3 | PASS |

**Notes:**
* For SMD devices reliability stress tests performed after preconditioning test (PC) according to JESD22

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**Document reference**
n.a.

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